



**PRELIMINARY**

**FastEdge™ Series**

**CY2DP314**

# 1 of 2:4 Differential Fanout Buffer

## Features

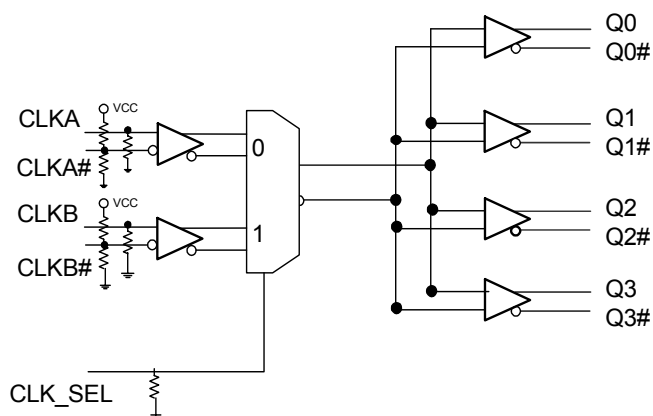
- Four ECL/PECL differential outputs
- Two ECL/PECL and HSTL differential inputs
- Hot-swappable/-insertable
- 50-ps output-to-output skew (typical)
- 100-ps device-to-device skew (typical)
- Less than 1-ps RMS typical jitter
- 500-ps propagation delay (typical)
- Operation from DC to above 1.5 GHz
- PECL and HSTL mode supply range:  $V_{CC} = 2.375V$  to  $3.465V$  with  $V_{EE} = 0V$
- ECL mode supply range:  $V_{EE} = -2.375V$  to  $-3.465V$  with  $V_{CC} = 0V$
- Industrial temperature range:  $-40^{\circ}C$  to  $85^{\circ}C$
- 20-pin SSOP package
- Temperature compensation as 100K ECL

## Description

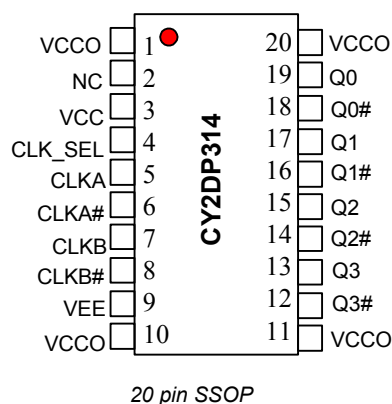
The CY2DP314 is a low-skew, low propagation delay 2-to-4 differential fanout buffer targeted to meet the requirements of high-performance clock and data distribution applications. The device is implemented on SiGe technology and has a fully differential internal architecture that is optimized to achieve low signal skews at operating frequencies of up to 1.5 GHz (full swing).

The device features two differential input paths that are multiplexed internally. This mux is controlled by the CLK\_SEL pin. The CY2DP314 may function not only as a differential clock buffer but also as a signal level translator and fanout an LVCMOS/LVTTL single-ended signal to four ECL/PECL differential loads. Since the CY2DP314 introduces negligible jitter to the timing budget, it is the ideal choice for distributing high-frequency, high-precision clocks across backplanes and boards in communication systems. Furthermore, advanced circuit design schemes, such as internal temperature compensation, ensure that the CY2DP314 delivers consistent, guaranteed performance over differing platforms.

## Block Diagram



## Pin Configuration



## Pin Description

Pin	Name	I/O	Type	Description
1,10,11,20	VCCO	+PWR	Power	Output power supply
2	NC			No connect
3	VCC	+PWR	Power	Power supply, positive connection
4	CLK_SEL	I,PD	ECL/PECL	pull down, selects between CLKA; pull up for CLKB signals
5,6	CLKA, CLKA#	I,PD <sup>[1]</sup> I,PC	ECL/PECL	Default differential clock input pair
7,8	CLKB, CLKB#	I,PD I,PC	ECL/HSTL	Alternate differential clock input pair
9	VEE <sup>[2]</sup>	–PWR	Power	Power supply, negative connection
18,16,14,12	Q[0:3]#	O,OE	ECL/PECL	Complement output
19,17,15,13	Q[0:3]	O,OE	ECL/PECL	True output

Table 1.

Control	Operation
CLK_SEL	
0	Default condition (no connection to the pin)
0	CLKA, CLKA# input pair is active. CLKA can be driven with ECL or PECL compatible signals with respective power configurations.
1	CLKB, CLKB# input pair is active. CLKB can be driven by HSTL compatible signals with respective power configurations.

## Governing Agencies

The following agencies provide specifications that apply to the CY2DP314. The agency name and relevant specification is listed below.

Table 2.

Agency Name	Specification
JEDEC	JESD 51 (Theta JA) JESD 8-6 (HSTL) JESD 8-2 (ECL) JESD 65-A (skew,jitter)
IEEE	1596.3 (Jitter specs)
UL	94 (Flammability rating)
Mil-Spec	883E Method 1012.1 (Thermal Theta JC)

### Notes:

1. In the I/O column, the following notation is used: I = Input, O = Output, PD = Pull-down, PU = Pull-up, PC = Pull-center, O = output, OE = open emitter and PWR = Power.
2. In ECL mode (negative power supply mode),  $V_{EE}$  is either  $-3.3V$  or  $-2.5V$  and  $V_{CC}$  is connected to GND (0V). In PECL mode (positive power supply mode),  $V_{EE}$  is connected to GND (0V) and  $V_{CC}$  is either  $+3.3V$  or  $+2.5V$ . In both modes, the input and output levels are referenced to the most positive supply ( $V_{CC}$ ) and are between  $V_{CC}$  and  $V_{EE}$ .

**Absolute Maximum Conditions**

Parameter	Description	Condition	Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage	Non-functional	-0.3	4.6	VDC
V <sub>CC</sub>	Operating Voltage	Functional	2.5 – 5%	3.3 + 5%	VDC
I <sub>BB</sub>	Output Reference Current	Relative to V <sub>BB</sub>	–	200	µA
V <sub>TT</sub>	Output Termination Voltage	V <sub>TT</sub> = 0V for V <sub>CC</sub> = 2.5V	–	V <sub>CC</sub> –2	VDC
V <sub>IN</sub>	Input Voltage	Relative to V <sub>CC</sub>	-0.3	V <sub>CC</sub> +0.3	VDC
V <sub>OUT</sub>	Output Voltage	Relative to V <sub>CC</sub>	-0.3	V <sub>CC</sub> +0.3	VDC
LU <sub>I</sub>	Latch-up Immunity	Functional	300		mA
T <sub>S</sub>	Temperature, Storage	Non-functional	-65	+150	°C
T <sub>A</sub>	Temperature, Operating Ambient	Functional	-40	+85	°C
T <sub>J</sub>	Temperature, Junction	Non-functional	–	150	°C
Ø <sub>Jc</sub>	Dissipation, Junction to Case	Functional			°C/W
Ø <sub>Ja</sub>	Dissipation, Junction to Ambient	Functional	40	60	°C/W
ESD <sub>h</sub>	ESD Protection (Human Body Model)		2000		V
M <sub>SL</sub>	Moisture Sensitivity Level				N.A.
G <sub>ATES</sub>	Total Functional Gate Count	Assembled Die	50		Each
FLM	Flammability Rating		V0		N.A.

**PECL/HSTL DC Specifications** (V<sub>CC</sub> = 2.5V ± 5% or V<sub>CC</sub> = 3.3 V ± 5%, V<sub>EE</sub> = GND, Temp. = -40°C to 85°C)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
V <sub>IL</sub>	Input Voltage, Low		V <sub>CC</sub> – 1.945	–	V <sub>CC</sub> –1.625	V
V <sub>IH</sub>	Input Voltage, High		V <sub>CC</sub> –1.165	–	V <sub>CC</sub> –0.880	V
I <sub>IN</sub>	Input Current <sup>[3]</sup>	V <sub>IN</sub> = [V <sub>ILMIN</sub> = 2.406V or V <sub>IHMAX</sub> = 1.655V] at V <sub>CC</sub> =3.465V	–	–	150	µA
<b>Clock Input Pair CLKA, CLKB (PECL Differential Signals)</b>						
V <sub>PP</sub>	Differential input voltage <sup>[4]</sup>	Differential operation	0.1	–	1.3	V
V <sub>CMR</sub>	Differential cross point voltage <sup>[5]</sup>	Differential operation	1.2	–	V <sub>CC</sub>	V
I <sub>IN</sub>	Input Current <sup>[3]</sup>	V <sub>IN</sub> = [V <sub>ILMIN</sub> = 2.406V or V <sub>IHMAX</sub> = 1.655V] at V <sub>CC</sub> = 3.465V	–	–	200	µA
<b>Clock Input Pair CLKB, CLKB (HSTL Differential Signals)</b>						
V <sub>DIF</sub>	Differential input voltage <sup>[6]</sup>		0.4	–	1.9	V
V <sub>X</sub>	Differential crosspoint voltage <sup>[7]</sup>		0.68	–	0.9	V
I <sub>IN</sub>	Input Current	V <sub>IN</sub> = V <sub>X</sub> ± 0.2V	–	–	150	µA
<b>PECL Outputs Q0–Q3, Q0–Q3 (PECL Differential Signals)</b>						
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = -30 mA <sup>[8]</sup>	V <sub>CC</sub> –1.2	–	V <sub>CC</sub> –0.7	V
V <sub>OL</sub>	Output Low Voltage V <sub>CC</sub> = 3.3V ± 5% V <sub>CC</sub> = 2.5V ± 5%	I <sub>OL</sub> = -5 ma <sup>[8]</sup>	V <sub>CC</sub> –1.945 V <sub>CC</sub> –1.945	–	V <sub>CC</sub> –1.5 V <sub>CC</sub> –1.3	V

**Notes:**

- Input have internal pullup/pulldown or biasing resistors which affect the input current.
- V<sub>PP</sub> (DC) is the minimum differential input voltage swing required to maintain device functionality
- V<sub>CMR</sub> (DC) is the crosspoint of the differential input signal. Functional operation is obtained when the crosspoint is within the V<sub>CMR</sub> (DC) range and the input swing lies within the V<sub>PP</sub> (DC) specification.
- V<sub>DIF</sub> (DC) is the amplitude of the differential HSTL input voltage swing required for device functionality.
- V<sub>X</sub> (DC) is the crosspoint of the differential HSTL input signal. Functional operations is obtained when the crosspoint is within the V<sub>X</sub> (DC) range and the input swing lies within the V<sub>PP</sub> (DC) specification.
- Equivalent to a termination of 50 Ω to V<sub>TT</sub>.

**PECL/HSTL DC Specifications** ( $V_{CC} = 2.5V \pm 5\%$  or  $V_{CC} = 3.3V \pm 5\%$ ,  $V_{EE} = GND$ , Temp. =  $\Delta 40^{\circ}C$  to  $85^{\circ}C$ )(continued)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
<b>Supply Current</b>						
$I_{EE}$	Max. Quiescent Supply Current without output termination current <sup>[9]</sup>	$V_{EE}$ pin	–	–	130	mA

**ECL DC Specifications** ( $V_{EE} = -2.5V \pm 5\%$  or  $V_{EE} = -3.3V \pm 5\%$ ,  $V_{CC} = GND$ ,  $T_A = \Delta 40^{\circ}C$  to  $85^{\circ}C$ )

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
$V_{IL}$	Input Voltage, Low		–1.945	–	–1.625	V
$V_{IH}$	Input Voltage, High	Define $V_{CC}$ and load current	–1.165	–	–0.880	V
$I_{IN}$	Input Current <sup>[10]</sup>	$V_{IN} = V_{IL}$ or $V_{IN} = V_{IH}$ , $V_{CC} = 3.465V$	–	–	200	uA
<b>Clock Input Pair CLK<sub>A</sub>, CLK<sub>A</sub> (ECL Differential Signals)</b>						
$V_{PP}$	Differential input voltage <sup>[11]</sup>	Differential operation	0.1	–	1.3	V
$V_{CMR}$	Differential cross point voltage <sup>[12]</sup>	Differential operation	$V_{EE}+1.2$	–	–0.3	V
$I_{IN}$	Input Current <sup>[10]</sup>	$V_{IN} = V_{IL}$ or $V_{IN} = V_{IH}$ , $V_{CC} = 3.465V$	–	–	200	uA
<b>ECL Outputs Q0–Q3, Q0–Q3 (ECL Differential Signals)</b>						
$V_{OH}$	Output High Voltage	$I_{OH} = -30\text{ mA}$ <sup>[13]</sup>	–1.2	–	–0.7	V
$V_{OL}$	Output Low Voltage $V_{EE} = -3.3V \pm 5\%$ $V_{EE} = -2.5V \pm 5\%$	$I_{OL} = -5\text{ mA}$ <sup>[13]</sup>	–1.945 –1.945	–	–1.5 –1.3	V
<b>Supply Current</b>						
$I_{EE}$	Maximum Quiescent Supply Current without output termination current <sup>[9]</sup>	$V_{EE}$ pin	–	–	130	mA

**AC Specifications** ([ECL:  $V_{EE} = -3.3\text{ VDC} \pm 5\%$  or  $V_{EE} = -2.5V \pm 5\%$ ,  $V_{CC} = GND$ ] or [HSTL/PECL:  $V_{CC} = 3.3V \pm 5\%$  or  $V_{CC} = 2.5V \pm 5\%$ ,  $V_{EE} = GND$ ] Temp =  $\Delta 40^{\circ}C$  to  $85^{\circ}C$ )<sup>[14]</sup>

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
<b>Clock Input Pair CLK<sub>A</sub>, CLK<sub>A</sub> (PECL or ECL Differential Signals)</b>						
$V_{PP}$	Differential input voltage <sup>[15]</sup>	Differential operation	0.1	–	1.3	V
$V_{CMR}$	Differential cross point voltage <sup>[16]</sup>	Differential operation	$V_{EE}+1.0$	–	–0.3	V
$F_{CLK}$	Input Frequency <sup>[17]</sup>	50% duty cycle Standard load	–	–	2200	MHz
$T_{PD}$	Propagation Delay CLK <sub>A</sub> or CLK <sub>B</sub> to Q0–Q3 pair	660-MHz 50% duty cycle Standard load Differential Operation	280	400	750	ps
<b>Clock Input Pair CLK<sub>B</sub>, CLK<sub>B</sub> (HSTL Differential Signals)</b>						
$V_{DIF}$	Differential input voltage <sup>[18]</sup>	660-MHz 50% duty cycle Standard load Differential Operation	0.4	–	1.9	V
$V_X$	Differential cross point voltage <sup>[19]</sup>	660-MHz 50% Standard load Differential Operation	0.68	–	0.9	V

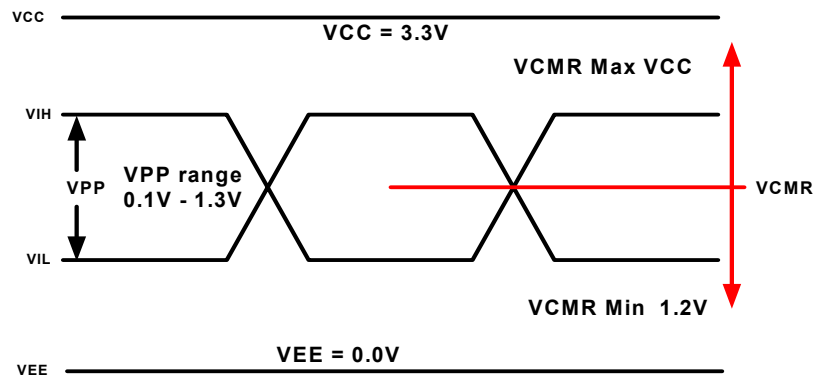
**Notes:**

9. Power Calculation:  $V_{CC} * I_{EE} + 0.5 (I_{OH} + I_{OL})(V_{OH} - V_{OL})$ (number of differential outputs used)
10. Input have internal pullup / pulldown or biasing resistors which affect the input current.
11. VPP (DC) is the minimum differential input voltage swing required to maintain device functionality.
12. VCMR (DC) is the crosspoint of the differential input signal. Functional operation is obtained when the crosspoint is within the VCMR (DC) range and the input swing lies within the VPP (DC) specification.
13. Equivalent to a termination of  $50\ \Omega$  to VTT.
14. AC characteristics apply for parallel output termination of  $50\ \Omega$  to VTT.
15. VPP (AC) is the minimum differential ECL/PECL input swing required to maintain AC characteristics including tpd and device-to-device skew.
16. VCMR (AC) is the crosspoint of the differential ECL/PECL input signal. Normal AC operation is obtained when the crosspoint is within the VCMR(AC) range and the input swing lies within the VPP(AC) specification. Violation of VCMR(AC) or VPP(AC) impacts the device propagation delay, device and part-to-part skew.
17. The CY2DP314 is fully operational up to 1.5 GHz with full PECL swing. Reduced swing up to TBD GHz.
18. VDIF (AC) is the minimum differential HSTL input voltage swing required to maintain AC characteristics including tkpd and device-to-device skew
19. VX(AC) is the crosspoint of the differential HSTL input signal. Normal AC operation is obtained when the crosspoint is within the VX(AC) range and the input swing lies within the VDIF(AC) specification. Violation of VX(AC) or VDIF(AC) impacts the device propagation delay, device and part-to-part skew.

**AC Specifications** ([ECL:  $V_{EE} = -3.3 \text{ VDC} \pm 5\%$  or  $V_{EE} = -2.5 \text{ V} \pm 5\%$ ,  $V_{CC} = \text{GND}$ ] or [HSTL/PECL:  $V_{CC} = 3.3 \text{ V} \pm 5\%$  or  $V_{CC} = 2.5 \text{ V} \pm 5\%$ ,  $V_{EE} = \text{GND}$ ] Temp =  $\text{D40jC}$  to  $85\text{jC}$ )(continued)<sup>[14]</sup>

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
$F_{\text{CLK}}$	Input Frequency	50% duty cycle Standard load Differential Operation	—	—	2200	MHz
$T_{\text{PD}}$	Propagation Delay CLKA or CLKB to Q0–Q3 pair	660-MHz 50% duty cycle Standard load Differential Operation	280	400	750	ps
<b>ECL Clock Outputs (Q0–3, Q0–3) (Differential)</b>						
$V_{O(P-P)}$	Differential output voltage (peak-to-peak)	Differential PRBS fo < 50 MHz fo < 0.8 GHz fo < 1.0 GHz	0.45 0.4 0.375	—	—	V
$t_{\text{sk(o)}}$	Output-to-output skew	50% duty cycle Standard load Differential Operation	—	—	50	ps
$t_{\text{sk(PP)}}$	Output-to-output skew (part-to-part)	50% duty cycle Standard load Differential Operation	—	—	500	ps
$t_{\text{JIT(CC)}}$	Output cycle-to-cycle jitter (Intrinsic)	50% duty cycle Standard load Differential Operation	—	—	1	ps rms
$t_{\text{sk(P)}}$	Output pulse skew <sup>[20]</sup>	50% duty cycle Standard load Differential Operation	—	—	50	ps
$t_r, t_f$	Output Rise/Fall time	50% duty cycle Differential 20%–80%	—	—	0.3	ns
TTB	Total Timing Budget	660-MHz 50% duty cycle Standard load	—	—	250	ps
$D_j$	Deterministic/Intrinsic Jitter	50% duty cycle Standard load	—	—	1	ps rms

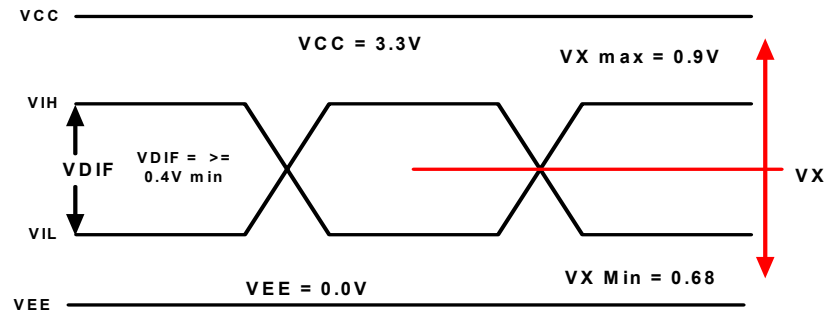
## Timing Definitions



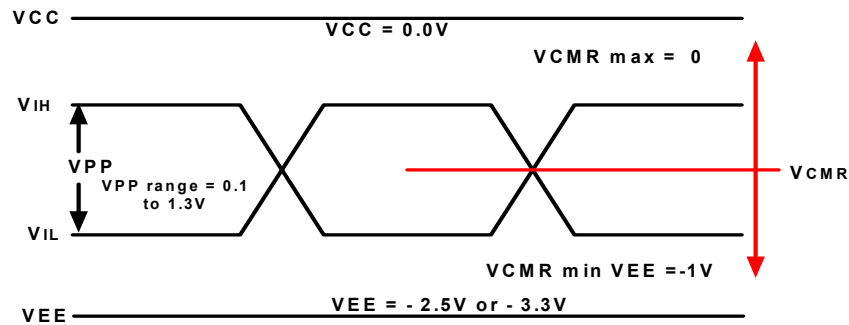
**Figure 1. PECL Waveform Definitions**

**Note:**

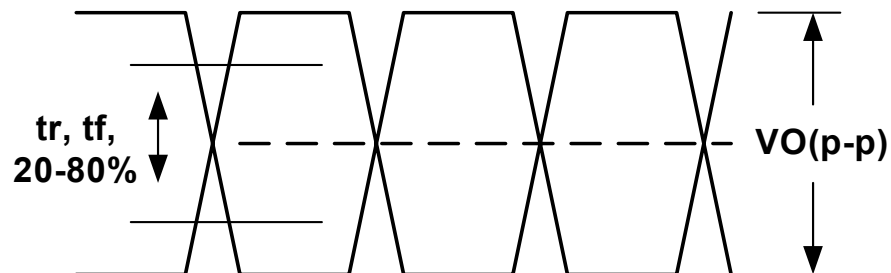
20. Output pulse skew is the absolute difference of the propagation delay times:  $|t_{\text{PLH}} - t_{\text{PHL}}|$ .



**Figure 2. HSTL Differential Waveform Definitions**



**Figure 3. ECL Differential Waveform Definitions**



**Figure 4. ECL/LVPECL Output**

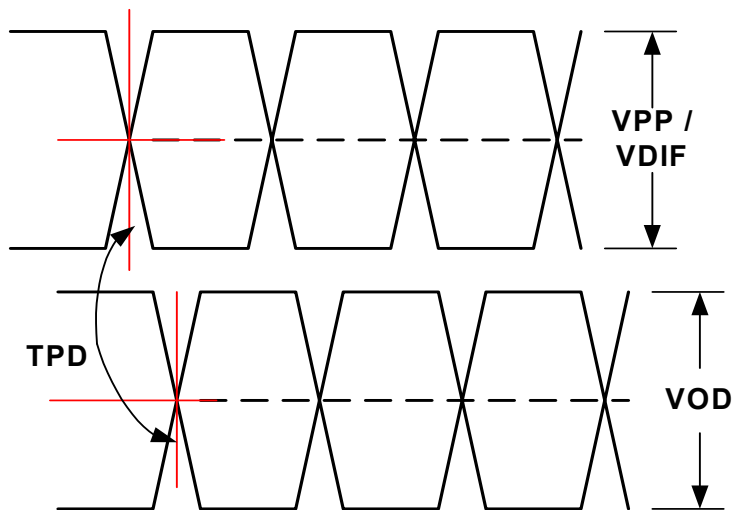
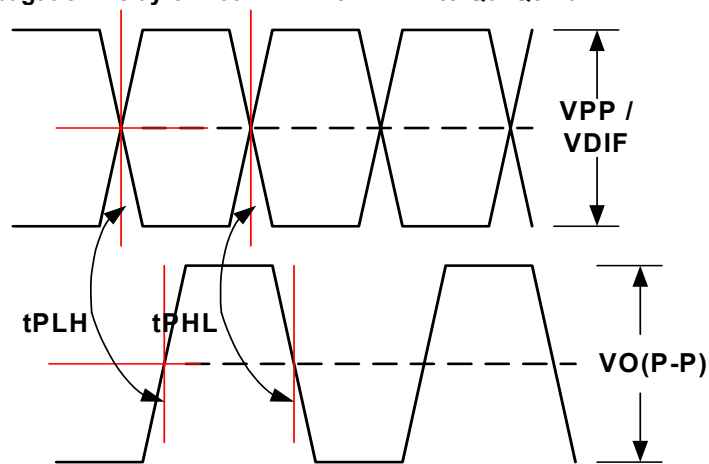
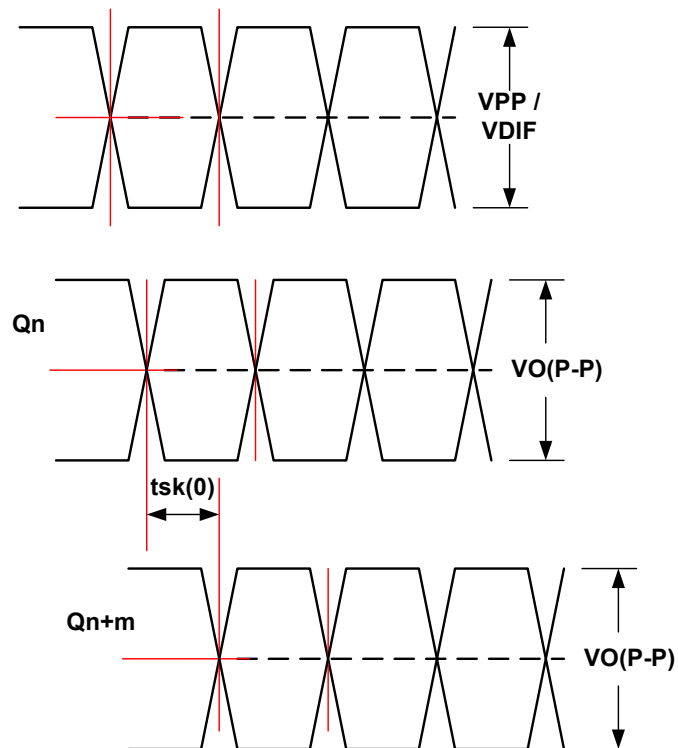


Figure 5. TPD Propagation Delay of Both CLKA or CLKB to Q0-Q3 Pair PECL/ECL/HSTL to PECL/ECL



$$\text{tsk(P) Output pulse skew} = |t_{PLH} - t_{PHL}|$$

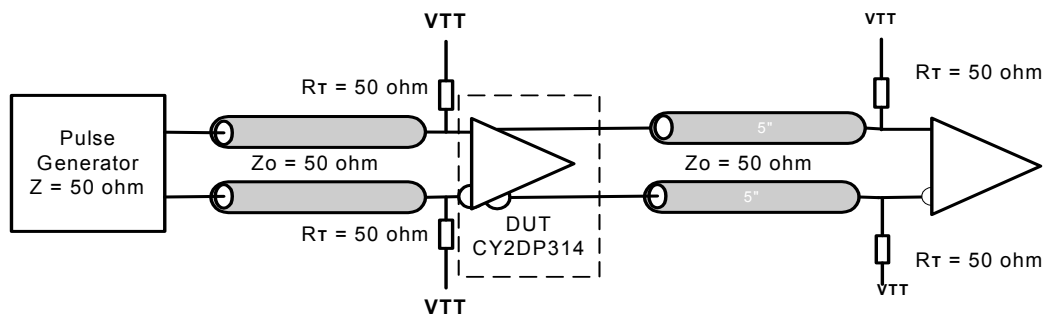
Figure 6. Output Pulse Skew



**Figure 7. Output-to-Output Skew**

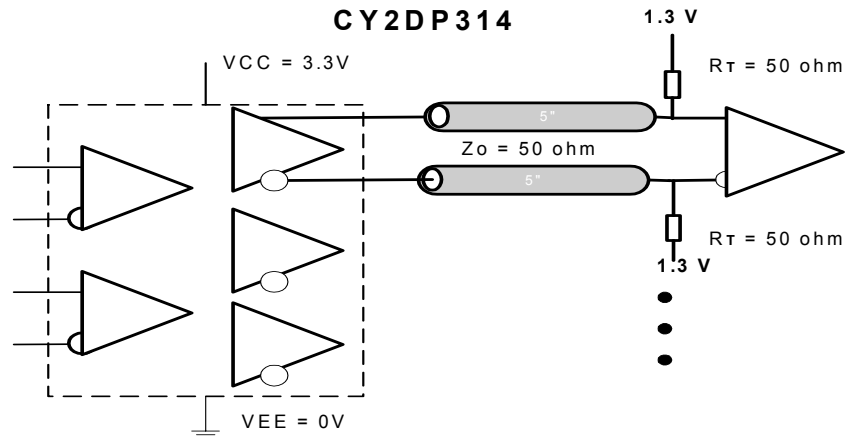
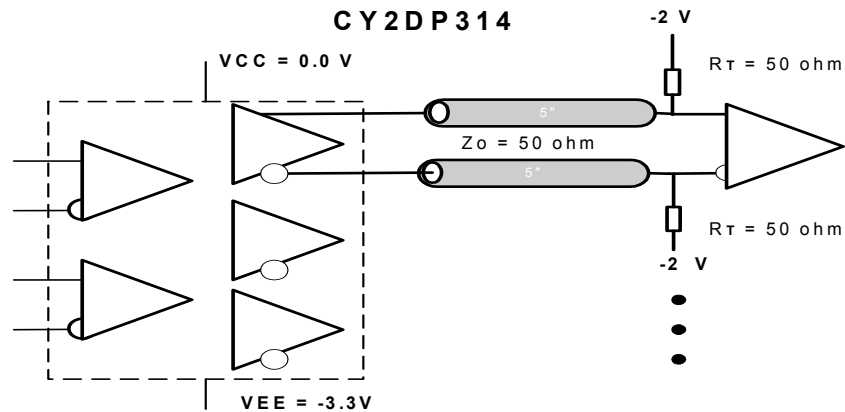
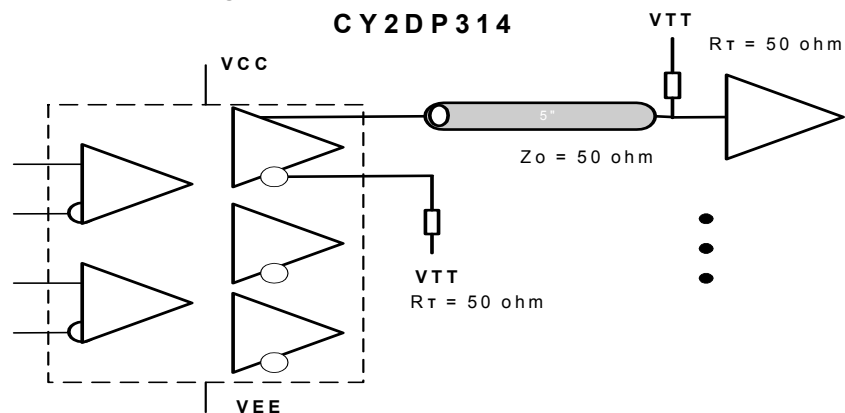
## Test Configurations

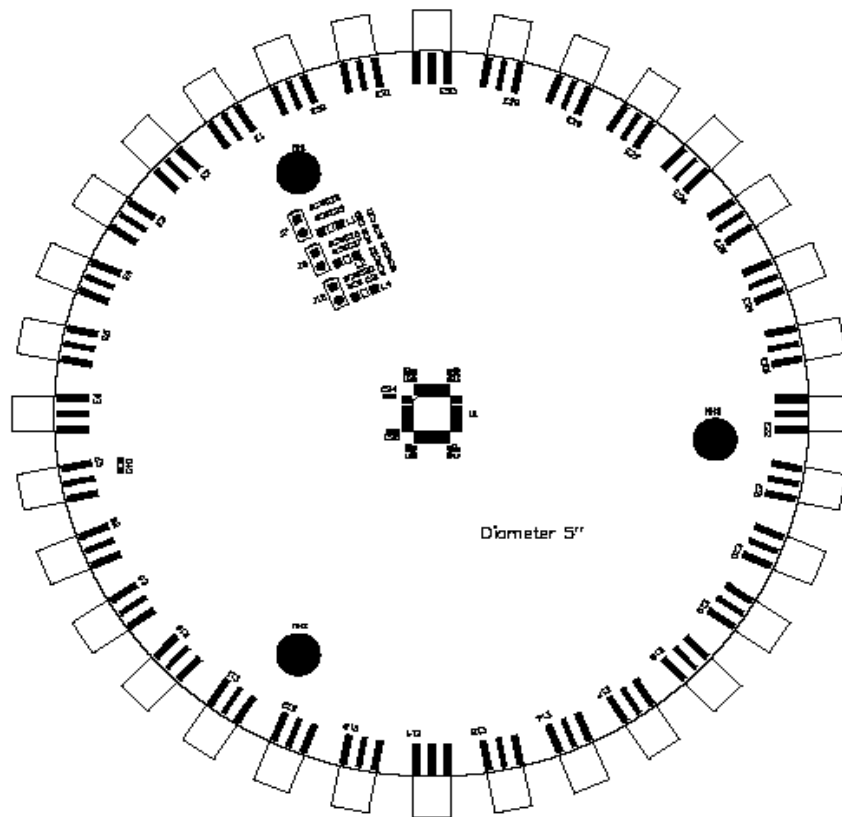
Standard test load using a differential pulse generator and differential measurement instrument.



**Figure 8. CY2DP314 AC Test Reference**



**Applications Information**
**Termination Examples**

**Figure 9. Standard LVPECL – PECL Output Termination**

**Figure 10. Standard ECL Output Termination**

**Figure 11. Driving a PECL/ECL Single-Ended Input**

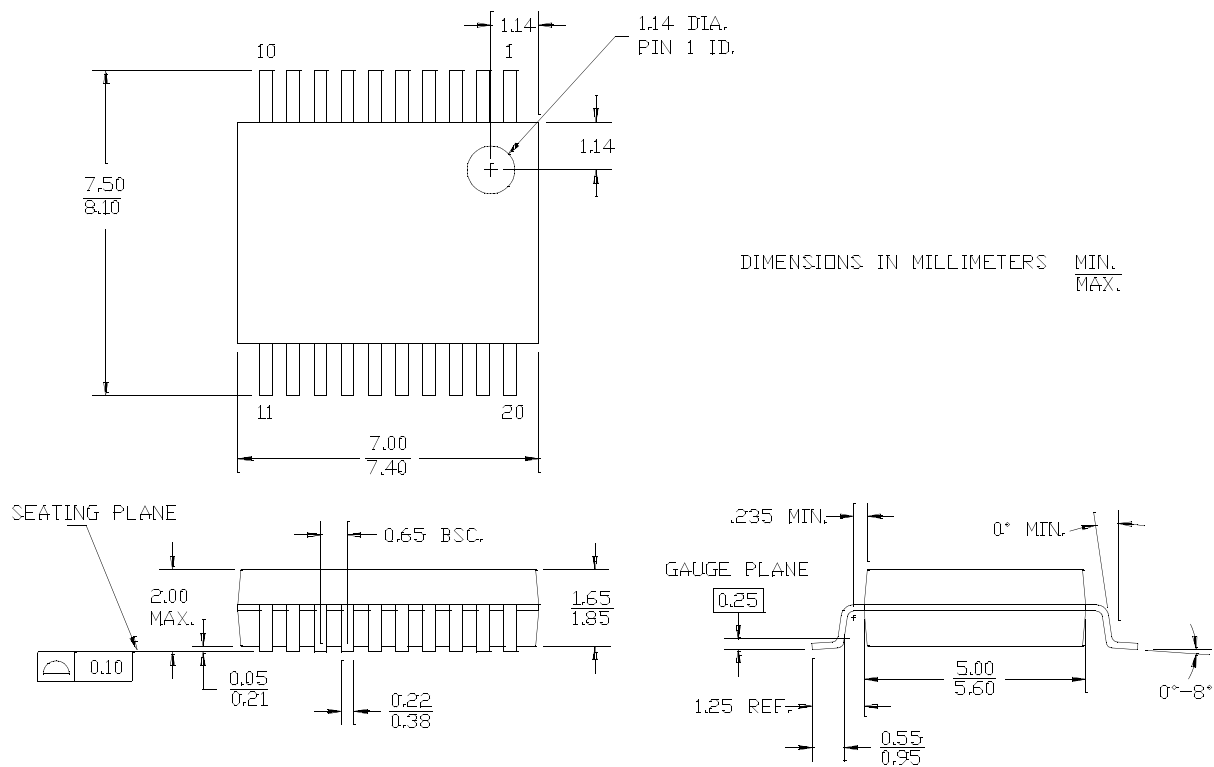


**Figure 12. Demonstration PCB**

Part Number	Package Type	Product Flow
CY2DP314OI	20 SSOP	Industrial, -40° to 85°C
CY2DP314OIT	20 SSOP-pin Tape and Reel	Industrial, -40° to 85°C

## Package Drawing and Dimensions

### 20-Lead (5.3 mm) Shrunk Small Outline Package O20



51-85077-\*C

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**Document History Page**

Document Title: CY2DP314 FastEdge™ SERIES 1 of 2:4 Differential Fanout Buffer Document #: 38-07550				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	126779	06/13/03	RGL	New Data Sheet
*A	128940	08/19/03	RGL	Changed the operation value from 1.5 GHz, reduced swing to 3 GHz to from DC to above 1.5 GHz Changed $V_{CC}$ value in the $I_{IN}$ parameter from 3.6V to 3.645V. Changed the $V_{OL}$ min value from $V_{CC}-1.9$ to $V_{CC}-1.945$ Changed the $I_{EE}$ max value from 48 mA to 130 mA Specified the max input frequency ( $F_{CLK}$ ) to 2200 MHz Specified the TTB max value to 250 ps
*B	See ECN	207710	RGL	Added Junction Temperature( $T_J$ ) parameter in the Absolute Max. Conditions Table Replaced $I_{CC}$ calculation with power calculation in the footnote